

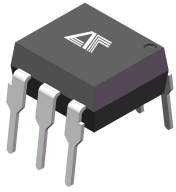
可控硅光耦 Thyristor optocoupler

MOC30VX

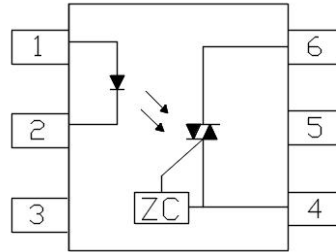
Product Data Sheet

AOTE DCC
RELEASE

DIP6



SMD6



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. NC
- 4. Terminal
- 5. NC
- 6. Terminal

◆ 封装逻辑原理图 Encapsulation logic schematic

MOC303X, MOC304X, MOC306X, MOC308X 系列光耦采用高效光电转换技术，结合先进封装工艺，提供输入输出间的可靠隔离，支持DIP、SMD两种封装形式，适配多样化场景需求。

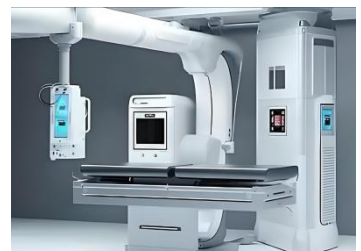
The MOC303X, MOC304X, MOC306X, MOC308X series optocoupler adopts high-efficiency photoelectric conversion technology and advanced packaging processes, providing reliable input-output isolation. It supports two package types (DIP, SMD) to meet diverse application requirements.

◆ 产品特征 Product features

- 输入-输出隔离电压 $V_{ios}=5000V_{rms}$
Input output isolation voltage: $V_{ios}=5000 V_{rms}$
- 断态输出端电压 $V_{DRM}=800,600,400,250$; Off-state output terminal voltage $V_{DRM}=800,600,400,250$;
- 峰值重复浪涌电流 $I_{TSM}=1A$; Peak repetitive surge current $I_{TSM}=1A$
- 爬电距离 $>7.0mm$; Creepage distance $>7.0mm$;
- 输入-输出绝缘距离 $>0.4mm$; Input-Output insulation Thickness $>0.4mm$
- 防潮等级 class1; MSL class1
- 产品符合 ROHS、REACH 及 HF 等环保法规要求;
The products comply with ROHS, REACH and HF;

◆ 应用领域 Applications

- 工业自动化与控制 Industrial Automation and Control;
PLC与变频器，伺服驱动系统，工业机器人PLC and frequency converter, servo drive system, industrial robot 过零型产品用于交流调压Zero crossing products are used for AC voltage regulation
- 家用电器与消费电子：Household appliances and consumer electronics 电机正反转、加热控制、调速等 Motor forward and reverse heating control, speed regulation, etc 智能照明系统中用于调光控制Used for dimming control in lighting systems
- 电力系统与能源管理：Power System and Energy Management 用于整流、变压器保护和电网监测Used for rectification, transformer protection, and power grid monitoring 应用于不间断电源（UPS）和电源保护设备Applied to uninterruptible power supply (UPS) and power protection equipment
- 医疗与特殊场景：Medical and Special Scenarios 用于心率监测仪、X光机等设备隔离与电路保护Used for isolation and circuit protection of devices such as heart rate monitors and X-ray machines



◆ 极限参数 Absolute Maximum Ratings (Ta =25°C)

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit
发射端 Input	正向电流 Forward Current	IF	60	mA
	反向电压 Backward Voltage	VR	6	V
	功耗 Power Dissipation	PD	70	mW
	额定值降低因子(在 Ta = 90°C 以上) Power dissipation Derating factor (above Ta = 90°C)	PDD	3.8	mW/°C
接收端 Output	断态输出端电压 Off-state output terminal voltage	VDRM	MOC303X 250	V
			MOC304X 400	
			MOC306X 600	
			MOC308X 800	
	峰值重复浪涌电流 (pw=100 μ s,120pps) Peak repetitive surge current (pw=100μs,120pps)	ITSM	1	A
	开启态电流 (均方根值) On-state current (root mean square value)	IT(RMS)	100	mA
	功耗 Power Dissipation	PC	300	mW
	额定值降低因子(在 Ta = 85°C 以上) Power dissipation Derating factor (above Ta = 90°C)		7.4	mW/°C
隔离电压 Isolation Voltage		Viso	5000	Vrms
工作温度 Operating Temperature		Topr	-55 ~ +110	°C
存储温度 Storage Temperature		Tstg	-55 ~ +125	°C
焊接温度 Soldering Temperature		Tsol	260	°C

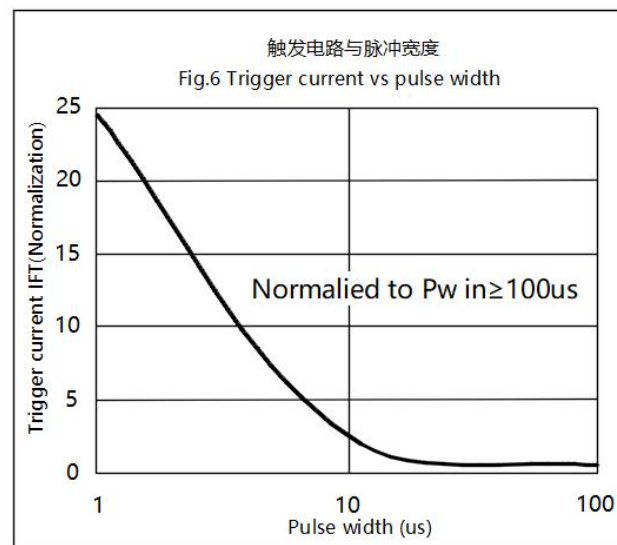
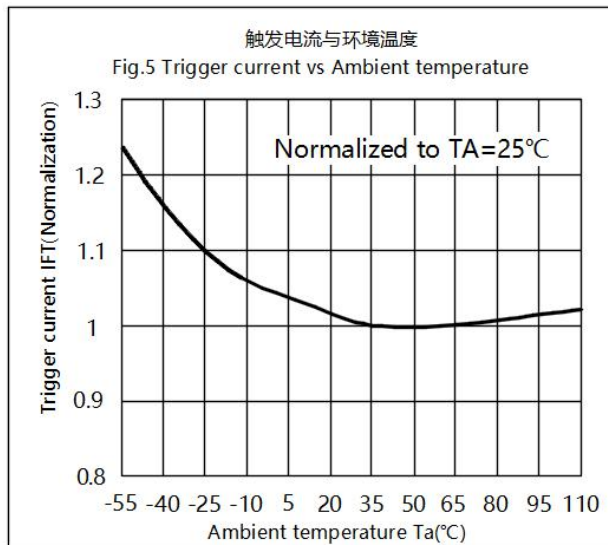
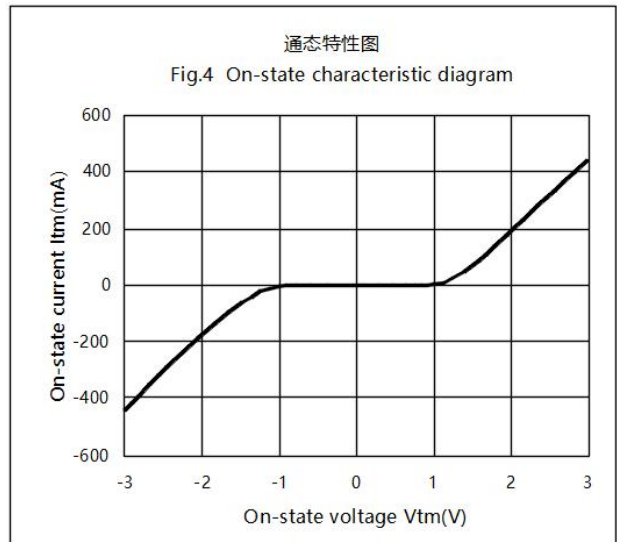
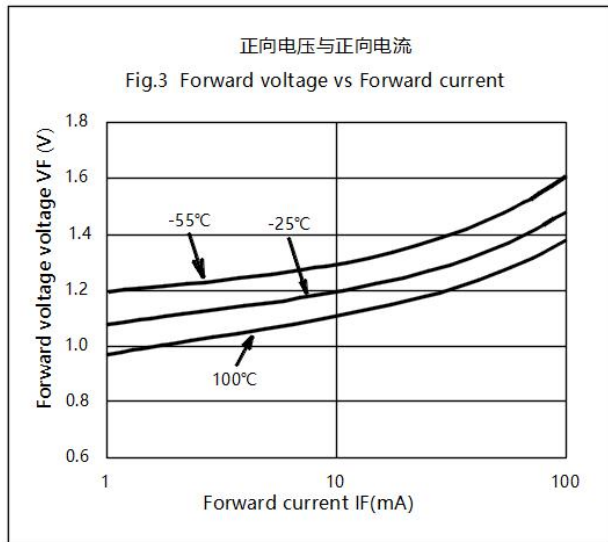
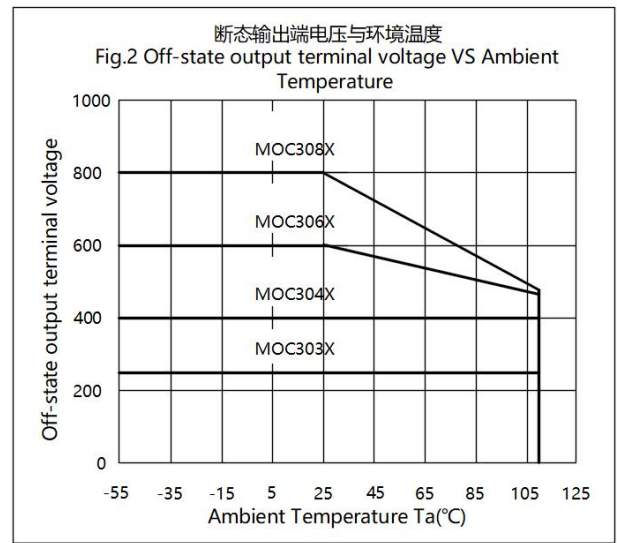
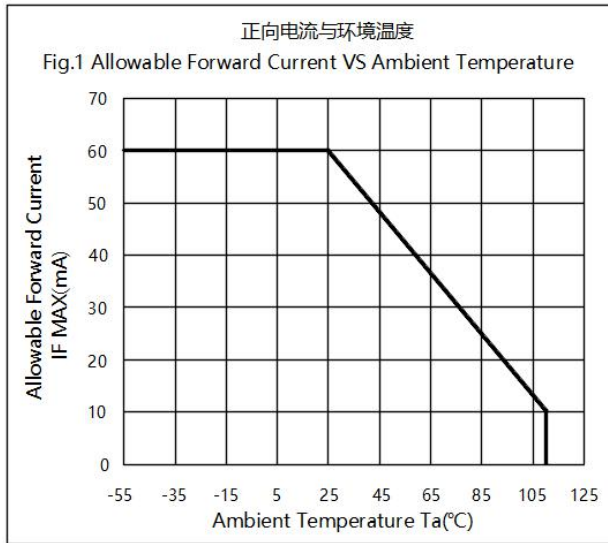
◆ 推荐操作条件 Recommended Operating Conditions

参数 Parameter	符号 Symbd	最小值 Min	最大值 Max	单位 unit
正向电流 Forward Current	IF	5	15	mA
峰值重复浪涌电流 (pw=100 μ s,120pps) Peak repetitive surge current (pw= 100μs,120pps)	ITSM	-	1	A
开启态电流 (均方根值) On-state current (root mean square value)	IT(RMS)	-	100	mA

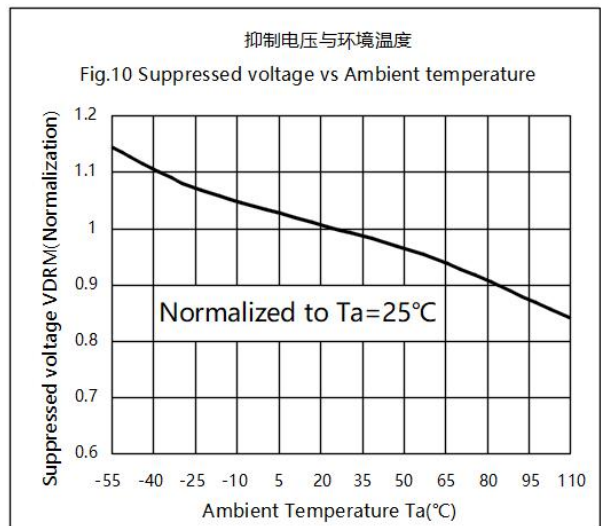
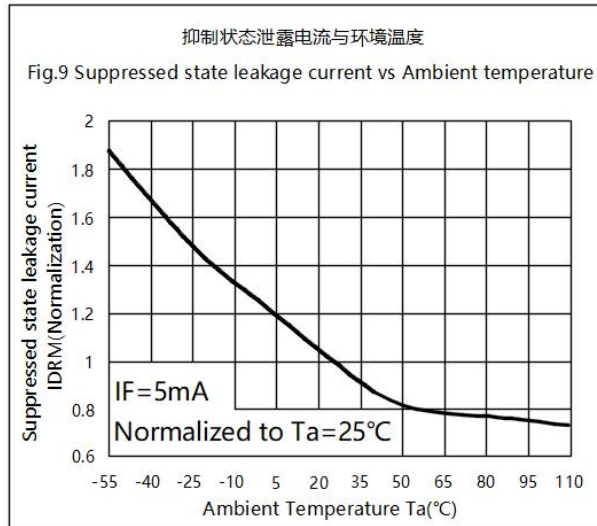
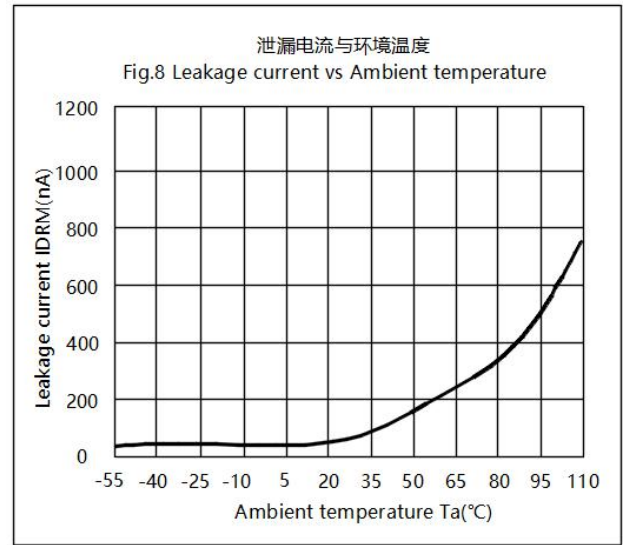
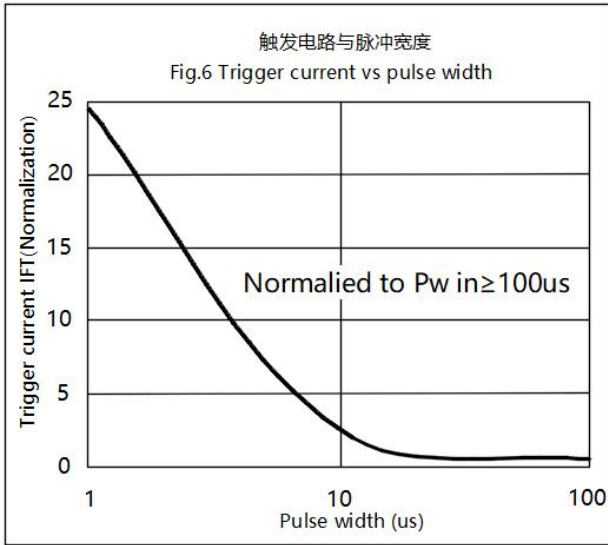
◆ 产品特性参数Product characteristic parameters (Ta =25°C)

参数 Parameter			符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	正向电压 Forward Voltage		VF	IF =20mA	-	1.23	1.5	V
	反向电流 Back current		IR	VR =6V	-	-	10	uA
接收端 Output	断态峰值电流 Off-state peak current	MOC303X	IDRM1	VDRM =Rated VDRM IF = 0mA	-	-	100	nA
		MOC304X			-	-	500	
		MOC306X			-	-	500	
		MOC308X			-	-	500	
	通态峰值电压 On-state peak voltage		VTM	ITM=100mA peak IF = Rated IFT	-	-	3	V
	断态电压临界上升率 Critical rise rate of off-state voltage	MOC303X	dv/dt	VPEAK =Rated VDRM, IF =0	1000	-	-	V/μs
		MOC304X			-	-	-	
		MOC306X			-	-	-	
		MOC308X			600	-	-	
	抑制电压 (MT1-MT2 高于多少电压不会触发) Suppression voltage (MT1-MT2 will not be triggered if it is higher than this voltage)		VInh	IF = Rated IFT	-	-	20	V
	抑制状态的漏电流 Leakage current in suppression state		IDRM2	IF = Rated IFT, VDRM=Rated VDRM, Off state	-	-	500	uA
传输特性 Transfer Characteristics	LED 触发电流 LED trigger current	MOC3031	IFT	主端电压 Main terminal Voltage =3V	-	-	15	mA
		MOC3041			-	-	15	
		MOC3061			-	-	15	
		MOC3081			-	-	15	
		MOC3032			-	-	10	
		MOC3042			-	-	10	
		MOC3062			-	-	10	
		MOC3082			-	-	10	
		MOC3033			-	-	5	
		MOC3043			-	-	5	
		MOC3063			-	-	5	
		MOC3083			-	-	5	
	维持电流 Maintain current		IH	-	-	280	-	uA

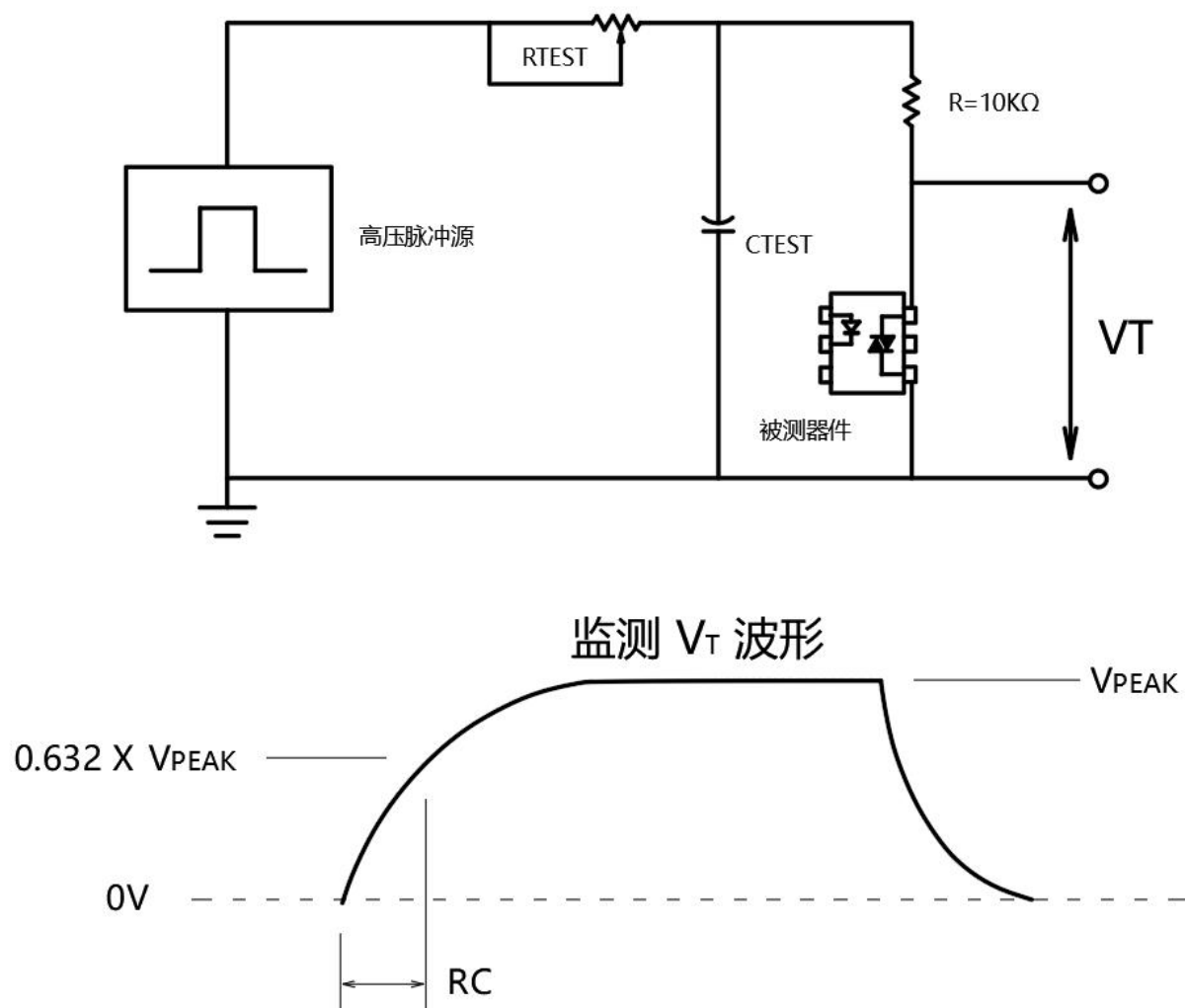
◆ 电性特性曲线 Electrical characteristic curve ($T_a = 25^\circ\text{C}$)



◆ 电性特性曲线 Electrical characteristic curve ($T_a = 25^\circ\text{C}$)

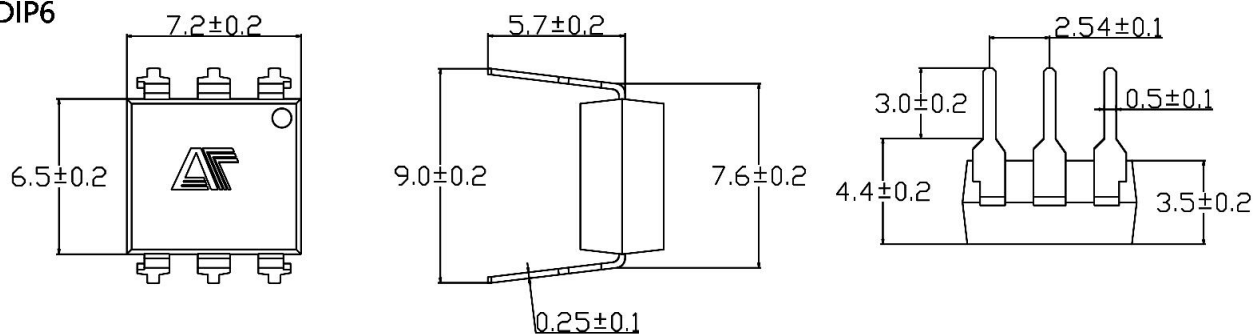


◆ 静态 dv/dt 测试电路和波形 Static dv/dt test circuit and waveform

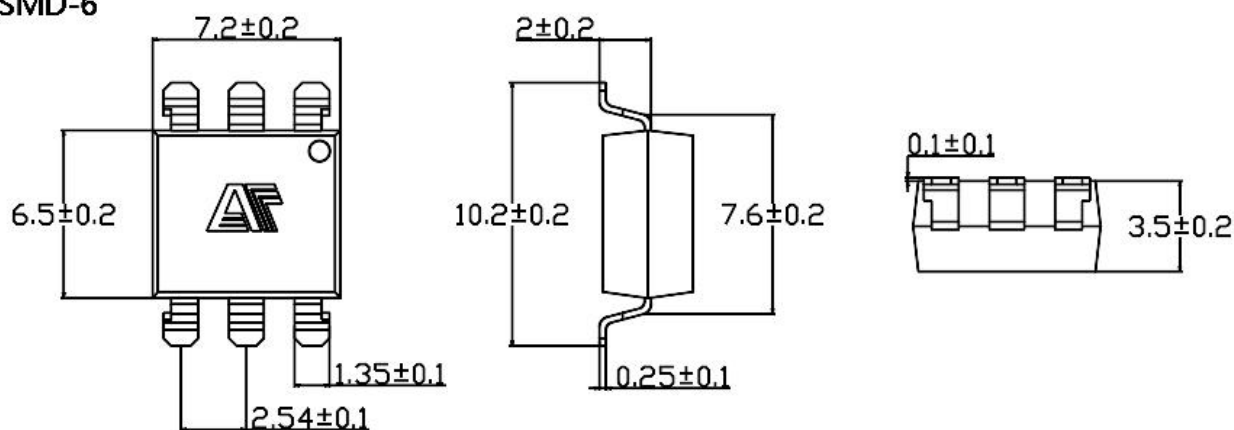


◆ 外形尺寸Overall dimension

DIP6

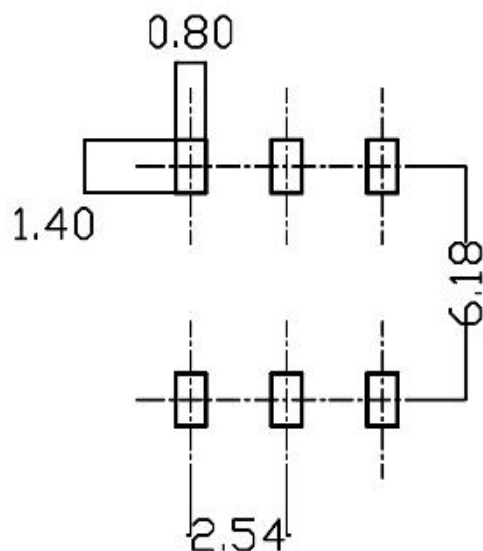


SMD-6



推荐焊盘:

Recommended



单位: mm

◆ 印字信息 Marking Information

- 印字中 “  ” 为奥特品牌LOGO
“  ” denotes LOGO
- 印字中 “Y” 代表年份; A(2018),B(2019),C(2020)
“Y” denotes YEAR: A(2018), B(2019), C(2020)
- 印字中 “WW” 代表周号
“WW” denotes Week' s number
- 印字中 “ E” 代表内部代码
“E” denotes Internal code
- 印字中的 “H” 代表无卤
“H” denotes Halogen-free

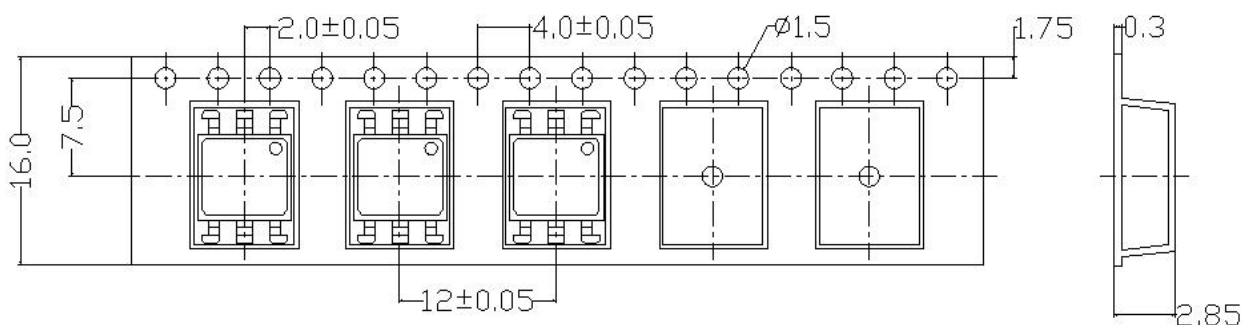
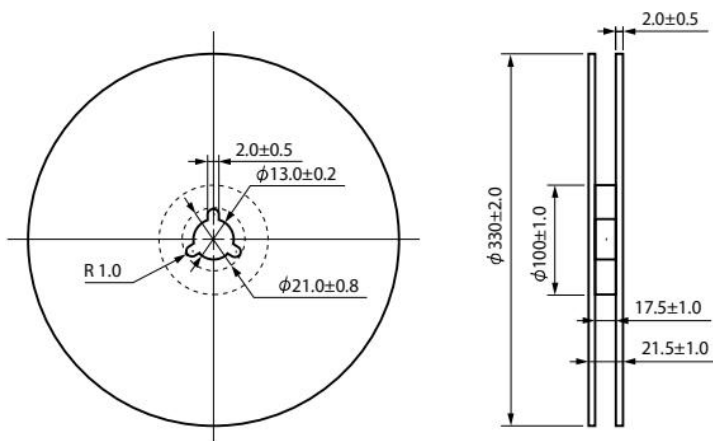


◆ 包装packing

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SMD6	卷盘 ($\phi 330$ mm 蓝盘)	1000 只/盘	2 盘/盒	10 盒/箱	450*390* 0.1mm	340*60* 340mm	620*360* 365mm	首尾端空至少 200mm
DIP6	管装 (500*12*11mm)	65 只/管	50 管/盒	10 盒/箱	不适用	525*128* 56mm	535*275* 300mm	每管使用蓝白胶 塞, 方向须一致
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SMD6	Reel ($\phi 330$ mm Blue)	1000 pcs/reel	2 reels/box	10 boxes/ctn	450*390* 0.1mm	340*60* 340mm	620*360* 365mm	Guard band 200mm min.
DIP6	Tube (500*12*11mm)	65 pcs /tube	50 tubes/box	10 boxes/ctn	NA	525*128* 56mm	535*275* 300mm	Endplug (blue) and Endplug (white) keep the direction

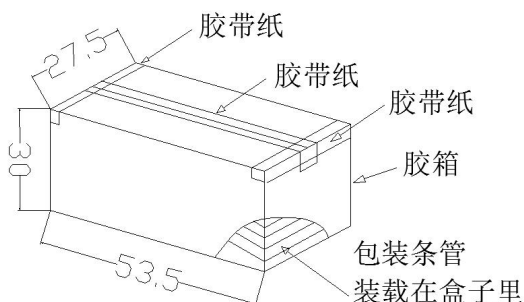
• 编带包装 Tape & Reel

- 1) 每卷数量: 1000 只;
Qty/reel: 1000 pcs.
- 2) 每箱数量: 20000 只;
Qty/ctn: 20000 pcs.
- 3) 内包装: 每盒 2 盘;
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



• 管条包装 Tape & Tube

- 1) 每管数量: 65 只;
Qty/Tube: 65 pcs.
- 2) 每箱数量: 32500 只;
Qty/ctn: 32500 pcs.
- 3) 内包装: 每盒 50 管;
Inner packing: 50 Tube/box.
- 4) 示意图 Schematic:

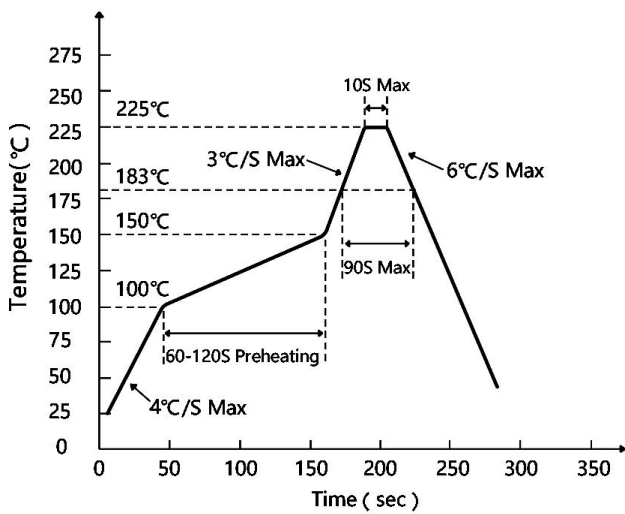


单位: mm

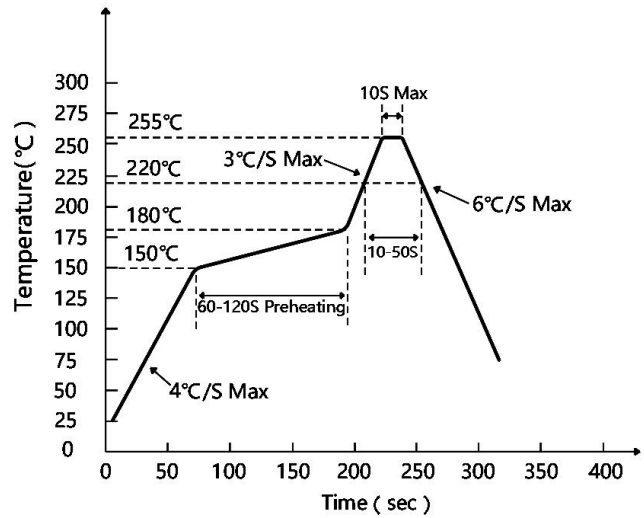
◆ 可靠性测试 Reliability Test Items And Conditions

实验项目 Test Items	参考标准 Reference	实验条件 Test Conditions	时间 Time	样品数 Quantity	判据 Criterion
可焊性 Solderability	JESD22-B102	Tsol= (245±5) °C, t=5s;	1 次1 times	22	0/22
耐焊接热 Resistance to Soldering Heat	JESD22-A106	Tsol= (260±5) °C, t=10s	3 次3 times	22	0/22
静电放电 ESD-HBM	JESD22-A114	Ta=25°C, HBM (2000V)	正反各 3 次 P&N 3 times	10	0/10
高温贮存 High emperature Storage	JESD22-A103	Ta=125°C	1000h	22	0/22
低温贮存 Low Temperature Storage	JESD22-A119	Ta= -55°C	1000h	22	0/22
冷热冲击 Thermal Shock	JESD22-A104	-55°C(15min)←→ 125°C(15min)	循环 300 次 300 cycles	22	0/22
常温寿命试验 Lifespan Test	JESD22-A108	Ta=25°C, IF=50mA , Vcc=5V	1000h	22	0/22
高温寿命试验 DC Operating Life	JESD22-A108	Ta=110°C, IF=20mA , Vcc=5V	1000h	76	0/76
高温高湿偏压 High Temperature High Humidity bias Voltage	JESD22-A101	Ta =85°C , RH=85% IF=0mA , VCE=64V	1000h	22	0/22
高温偏压 High Temperature bias Voltage	JESD22-A108	Ta =110°C , IF=0mA , VCE=80V	1000h	22	0/22
高压蒸汽试验 High pressure steam test	JESD22-A102	P=15PSIG , 121°C, 100%RH	96h	22	0/22

◆ **回流焊温度曲线图 Solder Reflow Profile**

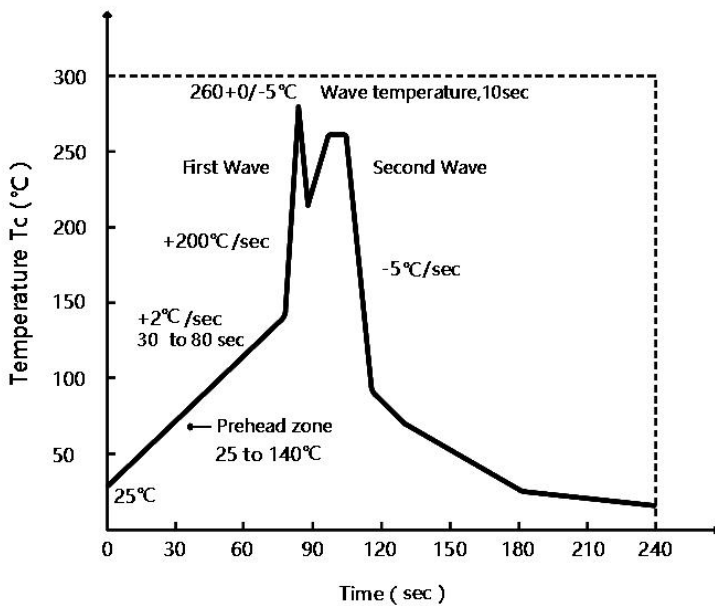


有铅制程 Lead Process



无铅制程 Lead Process

◆ **波峰焊温度曲线图 Wave Soldering Profile**



◆ **手工烙铁焊接 Soldering with hand soldering iron**

A. 手工烙铁焊仅用于产品返修或样品测试;

Hand soldering iron is only used for product rework or sample testing;

B. 手工烙铁焊要求: 温度 $350^{\circ}\text{C} \pm 5^{\circ}\text{C}$, 时间 $\leq 3\text{s}$.

Hand soldering iron requirements: Temperature: $350^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

◆ 注意 Attention

- 奥特半导体实施动态技术迭代机制，产品规格可能随工艺升级调整，最新技术参数以官网发布版本为准。

AOTE implements dynamic technical updates. Specifications are subject to change. Refer to the official website for the latest version.

- 用户需严格遵循本规格书限定的操作条件，因超范围使用（包括但不限于过载、高温、非兼容电路设计）导致的器件失效，不在质量保证范围内。

Users must strictly adhere to specified conditions. Failures caused by misuse (overload, high temperature, incompatible circuits) are excluded from warranty.

- 医疗设备、工业控制等关键场景应用前，需联系技术支持获取定制化验证方案。

Contact technical support for customized validation in critical applications (medical devices, industrial control).

- 本文档有效期至2025年12月31日，后续更新将通过官网公告推送。

This document is valid until Dec 31, 2025. Updates will be notified on the official website.

- 如需对技术参数或应用方案进行进一步确认，欢迎通过以下渠道获取官方支持：

For further clarification on technical specifications or application solutions, please contact us through official channels: